MICRO SIM CARD SOCKET PUSH-PUSH TYPE

5563 SERIES. Micro Sim Card Socket 8 contacts.

General Features

- Available in 8 contacts
- Accept Micro SIM card 8 contacts
- Contact area: 15 µ" gold plating over 50 µ nickel
- Solder area: Gold flash plating over 50 µ nickel
- Stand-off: 0 mm. With SMT fixing tabs.
- With card detect

Electrical Features

- Voltage rating: < 10 V
- Current rating: < 0.50 A
- Contact resistance: < 100 mΩ contact
- Dielectric withstanding voltage: 500 V AC/minute
- Insulation resistance: >1000 MΩ

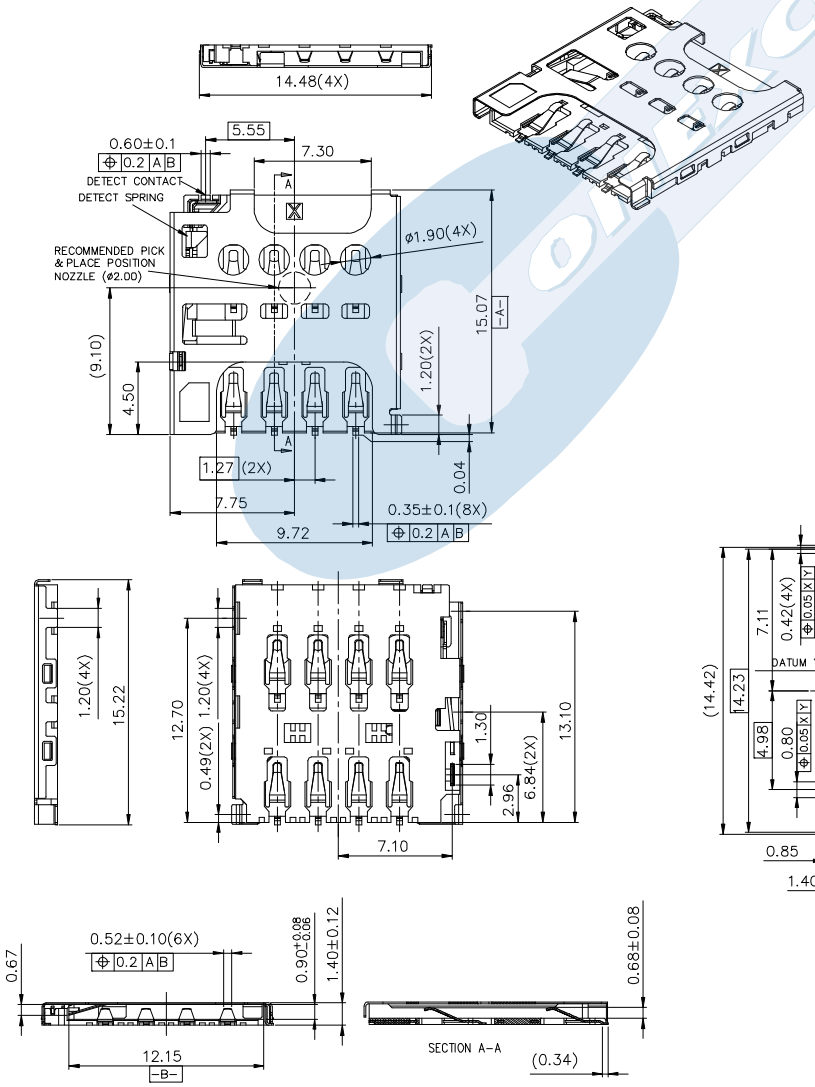
Materials

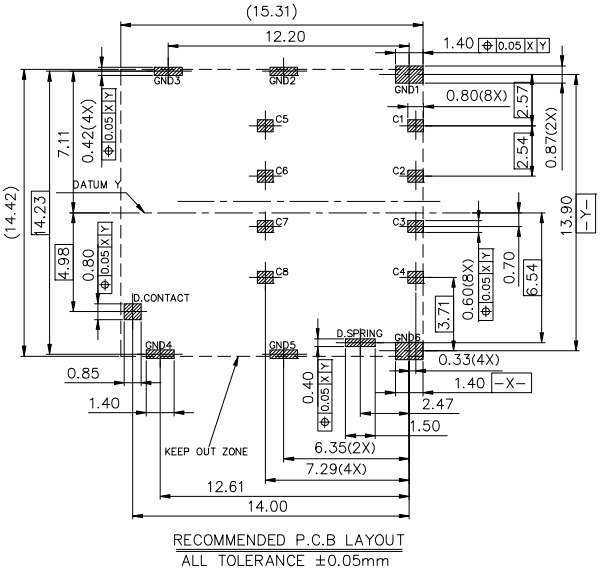
- Insulator: high temperature thermoplastic UL 94 V-0
- Contact: phosphor bronze
- Switch terminal: brass
- Operating temperature. -25°C to +85°C
- RoHS compliant

Mechanical Features

- Contact retention force: > 0.03 Kgf
- Insertion force: < 0.98 Kgf
- Withdrawall force: >0.050 Kgf
- Durability: 500 cycles

Dimensional Information





5563 - T- XX- E

1 2 3 4

1. Series

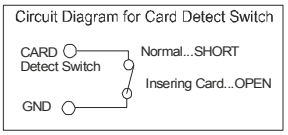
2. Plating Options

- T = **5.** 15µ" gold over nickel Recommended Finish

3. Number of circuits

- Available in 08 circuits

4. Packing Options

- E = **2.** Reel

SIM CARD Distribution Pin							
C1	C2	C3	C4	C5	C6	C7	C8
VCC	RST	CLK	NA	GND	VPP	I/O	Reser.